

# DMT080H4NLCMI-1H PRODUCT SPECIFICATION

Version 0.1 May 26, 2022

TBD

Customer's Approval							
<u>Signature</u>	<u>Date</u>						

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### **Revision History**

VERSION	DATE	DESCRIPTION	AUTHOR
0.1	May 26, 2022	Preliminary	Victoria Ho

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## **Table of Contents**

1.	GENE	ERAL DESCRIPTION	5
	1.1	Introduction	5
	1.2	Main Features	5
	1.3	CTP Features	6
2.	MECH	HANICAL SPECIFICATION	7
	2.1	Mechanical Characteristics	7
	2.2	Mechanical Drawing	8
3.	ELECT	TRICAL SPECIFICATION	9
	3.1	Absolute Maximum Ratings	9
	3.2	Electrical Characteristics	9
	3.3	Interface Pin Assignment	10
	3.4	Block Diagram	12
	3.5	Timing Characteristics	13
4.	OPTIO	CAL SPECIFICATION	17
	4.1	Optical Characteristics	17
5.	LED B	BACKLIGHT SPECIFICATION	21
	5.1	LED Backlight Characteristics	21
	5.2	INTERNAL CIRCUIT DIAGRAM	21
6.	PACK	(AGING	22
7.	QUAL	LITY ASSURANCE SPECIFICATION	23
	7.1	Conformity	23
	7.2	Environment Required	23
	7.3	Delivery Assurance	23
	7.4	Dealing with Customer Complaints	30
8.	RELIA	ABILITY SPECIFICATION	31
	8.1	Reliability Tests	31
9.	HAND	DLING PRECAUTIONS	32
	9.1	Handling Precautions	32
	9.2	Storage Precautions	33





9.3	Designing Precautions	3
9.4	Operation Precautions	3
	·	
9.5	Other Precautions	3 <sup>,</sup>



## 1. General Description

#### 1.1 Introduction

This is an 8.0" size colour active matrix TFT LCD module that uses amorphous silicon TFT as a switching device. The display is normally black mode, transmissive, and featuring high contrast and excellent colour saturation. The resolution of the TFT-LCD is 800 x 1280 and can display up to 16.7M colours. The display module supports LVDS interface and optical bonding touch panel.

#### 1.2 Main Features

ltem	Contents				
Display Type	TFT LCD				
Screen Size	8.0" Diagonal				
Display Format	1280 x RGB x 800 Dots				
No. of Colour	16.7M				
Overall Dimensions	238±0.2 (W) x 179.94±0.2 (H) x 4.85±0.5 (D) mm				
Active Area	172.224 (W) x 107.64 (H) mm				
Mode	Normally Black / Transmissive / IPS				
Viewing Direction	All round				
Interface	LVDS				
Driver IC	ILI9881C & LT9211				
Backlight Type	LED, White, 21 chips				
Touch Panel	СТР				
Touch Interface	I <sup>2</sup> C				
Touch Driver IC	ST1727				
Bonding Type	Optical Bonding				
Operating Temperature	-10°C ~ +50°C				
Storage Temperature	-20°C ~ +60°C				
ROHS	Compliant to RoHS 2.0				



### 1.3 CTP Features

ltem	Contents				
CTP Technology	Mutual Capacitor				
Input Method	Finger				
Touch Point	5 Point				
Positional Accuracy	2.5mm at 4 edges and 1.5mm at center				
Cover Glass	Soda lime glass, chemically hardened				
Hardness	6H				
Optical Transmittance	87%				
Touch Controller	ST1727				
Interface to Host	I <sup>2</sup> C				
I <sup>2</sup> C Address	0X55				
Connection Type	ZIF Connector				



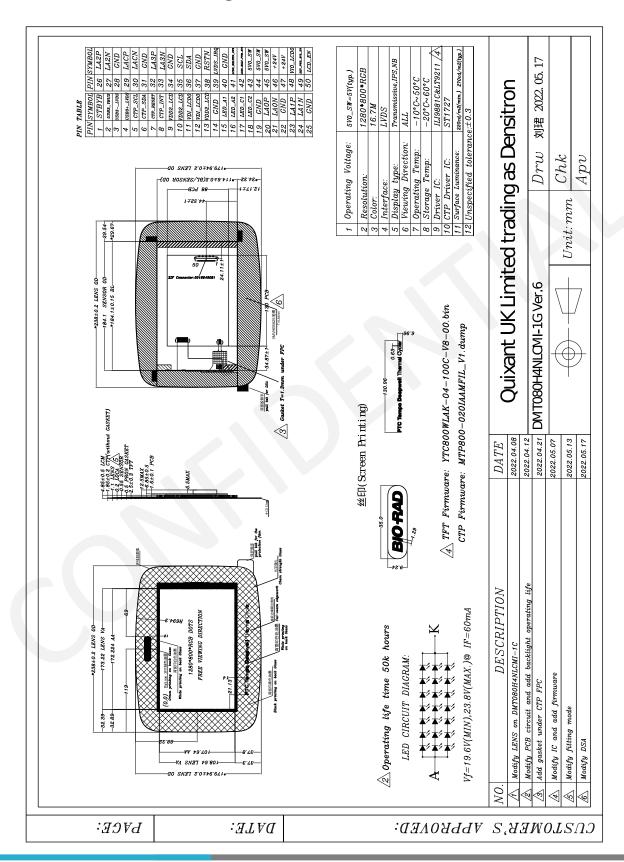
## 2. Mechanical Specification

### 2.1 Mechanical Characteristics

Item	Characteristic	Unit			
Display Format	1280 x 800 x RGB	Dots			
Overall Dimensions	238±0.2 (W) x 179.94±0.2 (H) x 4.85±0.5 (D)	mm			
Active Area	172.224 (W) x 107.64 (H)	mm			
Pixel Pitch	0.13455 x 0.13455	mm			
Weight	TBD	g			
IC Controller/Driver	ILI9881C & LT9211				



### 2.2 Mechanical Drawing





## 3. Electrical Specification

### 3.1 Absolute Maximum Ratings

AGND = GND = 0V, Ta =  $25^{\circ}$  C

Item	Symbol	Min	Max	Unit	Note
Operating Temperature	Topr	-10	50	°C	-
Storage Temperature	T <sub>STG</sub>	-20	60	°C	-

**Note 1:** When this module is used beyond the above absolute maximum ratings, permanent breakage of the module may occur. For normal operations, it is desirable to use this module under the conditions according to Section 3.2 "Electrical Characteristics", to avoid malfunctioning.

Note 2: Background colour changes slightly depending on ambient temperature. This phenomenon is reversible.

Note 3: Please refer to item of RELIABILITY.

#### 3.2 Electrical Characteristics

#### 3.2.1 Recommended Operating Condition

AGND = GND = 0V, Ta =  $25^{\circ}$  C

ltem	Symbol	Condition	Min	Тур.	Max	Unit	Note
Power Voltage	5V0_SW	-	-	5	-	V	-
Input Logic High Voltage	VIH	-	0.7IOVCC	-	IOVCC	V	IOVCC=1.8V
Input Logic Low Voltage	VIL	-	-0.3	-	0.3IOVCC	V	IOVCC=1.8V



## 3.3 Interface Pin Assignment

### 3.3.1 Pin Assignment

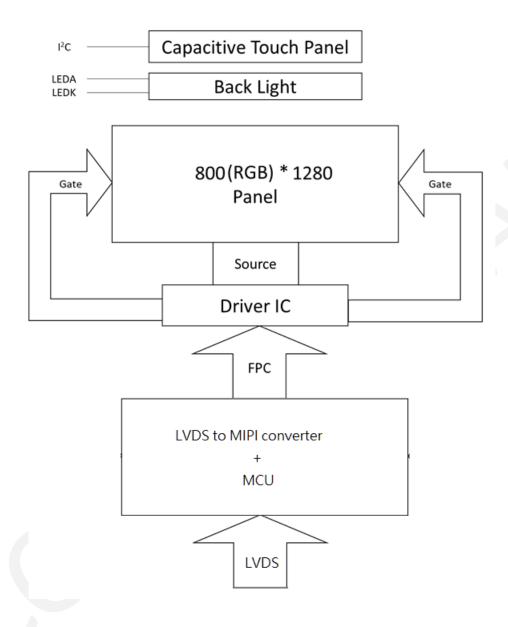
No.	Symbol	I/O	Function
1	STBYB	-	No connection
2	USB3_VBUS	-	No connection
3	USB3LVDS	-	No connection
4	USB3+_LVDS	-	No connection
5	CTP_SCL	ı	TP clock Signal.
6	CTP_SDA	ı	TP data Signal.
7	CTP_RESET	ı	TP reset Input pin.
8	CTP_INT	0	External interrupt to the host.
9	VDD2_LCD	-	No connection
10	VDD2_LCD	-	No connection
11	VDI_LCD0	-	No connection
12	VDI_LCD0	-	No connection
13	VDD2_LCD	-	No connection
14	GND	Р	Ground
15	LED_A1	Р	LED anode
16	LED_A2	-	No connection
17	LED_C1	Р	LED cathode
18	LED_C2	-	No connection
19	GND	Р	Ground
20	LAOP	ı	+LVDS differential data input
21	LAON	ı	-LVDS differential data input
22	GND	Р	Ground
23	LA1P	ı	+LVDS differential data input
24	LA1N	ı	-LVDS differential data input
25	GND	I	Ground
26	LA2P	I	+LVDS differential data input
27	LA2N	I	-LVDS differential data input
28	GND	Р	Ground
29	LACP	ı	+LVDS differential clock input
30	LACN	ı	-LVDS differential clock input
31	GND	Р	Ground



No.	Symbol	I/O	Function
32	LA3P	ı	+LVDS differential data input
33	LA3N	I	-LVDS differential data input
34	GND	Р	Ground
35	SCL	-	No connection
36	SDA	-	No connection
37	GND	Р	Ground
38	RSTN	I	The external reset input Initializes the chip with a low input.  Be sure to execute a power-on reset after supplying power.  Fix to VDDI level when it's not in use.
39	LVDS_IRQ	-	No connection
40	GND	Р	Ground
41	LCDO_BKLTEN_3V3	-	No connection
42	LCDO_BKLT_PWM_3V3	-	No connection
43	5V0_SW	Р	Power supply
44	5V0_SW	Р	Power supply
45	5V0_SW	Р	Power supply
46	+24V	-	No connection
47	+24V	-	No connection
48	VIO_LCDO	-	No connection
49	DEV_PWR_3V3_SW	-	No connection
50	LCD_EN	1	Data input enable



### 3.4 Block Diagram





## 3.5 Timing Characteristics

#### 3.5.1 AC Electrical Characteristics

#### LVDS Receiver AC Specifications

Symbol	Description	Condition	Min	Тур.	Max	Unit	Note
CLK	Output clk cycle	-	6.25	Тс	37	ns	-
ТО	Input data position0	-	-0.15	0	0.15	ns	-
T1	Input data position1	-	Tc/7-0.15	-	Tc/7-0.15	ns	-
T2	Input data position2	-	2Tc/7-0.15	-	2Tc/7-0.15	ns	-
Т3	Input data position3	-	3Tc/7-0.15	-	3Tc/7-0.15	ns	-
T4	Input data position4	-	4Tc/7-0.15	-	4Tc/7-0.15	ns	-
T5	Input data position5	-	5Tc/7-0.15	-	5Tc/7-0.15	ns	-
Т6	Input data position6	-	6Tc/7-0.15	-	6Tc/7-0.15	ns	-

#### LVDS Transmitter AC Specifications

Symbol	Description	Condition	Min	Тур.	Max	Unit	Note
CLK	Output clk cycle	-	6.25	Тс	37	ns	-
trise	VOD rise time, 20%		250	350	500	ps	-
tfall	VOD fall time, 20% to 80%	-	250	350	500	ps	-
T0	Output data position0	-	-0.15	0	0.15	ns	-
T1	Output data position1	-	Tc/7-0.15	-	Tc/7-0.15	ns	-
T2	Output data position2	-	2Tc/7-0.15	-	2Tc/7-0.15	ns	-
Т3	Output data position3	-	3Tc/7-0.15	-	3Tc/7-0.15	ns	-
T4	Output data position4	-	4Tc/7-0.15	-	4Tc/7-0.15	ns	-
T5	Output data position5	-	5Tc/7-0.15	-	5Tc/7-0.15	ns	-
Т6	Output data position6	-	6Tc/7-0.15	-	6Tc/7-0.15	ns	-



#### 3.5.2 DC Electrical Characteristics

#### LVDS Receiver DC Specifications

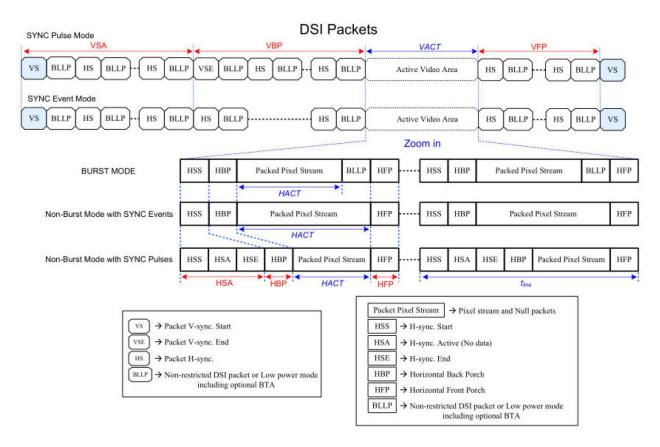
Symbol	Description	Condition	Min	Тур.	Max	Unit	Note
VIDTH	Differential input high			_	50	mV	
VIDIA	voltage threshold	-	-	-	50	mv	-
VIDTL	Differential input low voltage		Γ0	_		mV	
VIDIL	threshold	50		-	-	IIIV	-
VCMRXDC	Input common mode voltage	-	0	1200	1800	mV	-
Rterm	Termination Resister	-	80	100	125	Ω	-
MIDTH	Differential input high				ΓΟ.	ma\/	
VIDTH	voltage threshold	-	-	-	50	mV	

#### LVDS Transmitter DC Specifications

Symbol	Description	Condition	Min	Тур.	Max	Unit	Note
VOD	Differential Out Voltage: RL=100 $\Omega$	-	150	350	500	mV	-
△VOD	Change in VOD between complementary output states: $\label{eq:RL=100} \mathbf{\Omega}$	-	-	-	35	mV	-
VOC	Common Mode Voltage: RL=100 $\Omega$	_	1.1	1.25	1.4	V	-
△voc	Change in VOC between complementary output states: $\label{eq:RL=100} \mathbf{\Omega}$	-	-	-	35	mV	-
IOS	Output short circuit current: Vout=0V, RL=100 $\Omega$	-	-	-	-24	mA	-
IOZ	Output TRI-State Current:  Vout=0V to VCC	-	-	-	±10	uA	-



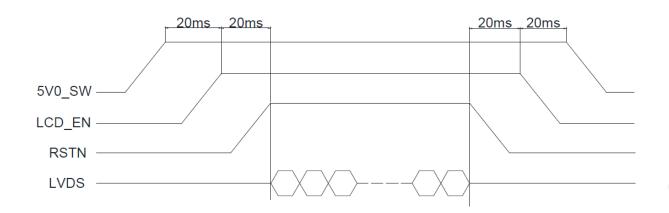
#### 3.5.3 Timing



Parameters	Symbols	Min.	Тур.	Max.	Units
Vertical sync. active	VSA	-	4	-	Line
Vertical Back Porch	VBP		30	-	Line
Vertical Front Porch	VFP	-	30		Line
Active lines per frame	VACT	-	1280	-	Line
Horizontal sync. active	HSA	•	4		Pixel
Horizontal Back Porch	HBP		70	*1	Pixel
Horizontal Front Porch	HFP		70		Pixel
Active pixels per line	HACT	-	800		Pixel
Line time	tine	TBD		-	bps/lane
Bit rate	BR <sub>bps</sub>	200		Note 5	Line



### 3.5.4 Power ON/OFF Sequence





## 4. Optical Specification

## 4.1 Optical Characteristics

Charac	cteristics	Symbol	Conditions	Min	Тур.	Max	Unit	Note
Contra	st Ratio	CR	$\theta = 0^{\circ}$	900	1200	-	-	1, 3
Respo	nse time	TR + TF	25°C	-	-	35	ms	1, 4
<u>e</u>	Left	θ <sub>x</sub> -		-	80	-		
Viewing Angle	Right	θх+	CD>10	-	80	-	Danua	2
wing	Up	θ <sub>Y</sub> +	CR≥10	-	80	-	Degree	2
Ş	Down	Өү-		-	80	-		
	DI	Rx		(0.598)	(0.638)	(0.678)		
	Red	Ry		(0.310)	(0.350)	(0.390)		
ticity	6	Gx		(0.297)	(0.337)	(0.377)		
Colour Chromaticity	Green	Gy	0 00	(0.555)	(0.595)	(0.635)		4.5
r Chr	Dive	Bx	$\theta = 0^{\circ}$	(0.117)	(0.157)	(0.197)	_	1, 5
nolo	Blue	Ву		(0.068)	(0.108)	(0.148)		
0	\A/I-:+-	Wx		(0.275)	(0.315)	(0.355)		
	White	Wy		(0.308)	(0.348)	(0.388)		
Lum	inance	L	-	220	270	-	cd/m²	6, 7
Unif	ormity	U		75	-	-	%	6

#### **Test Conditions:**

- 1. If= 60 mA (Backlight current), 5V0\_SW = 5 V, the ambient temperature is 25°C.
- 2. The test systems refer to Note 2.



Note	ltem	Test method				
1	Definition of Optical Measurement System	The optical characteristics should be operation, the optical properties at screen. ALL input terminals LCD parcenter area of the panel.  LCD Panel 500mm  Field Photo detector	re measured at the cernel must be ground when the center of the center o	iter point of t	he LCD	
		Contrast Ratio Luminance Lum Uniformity Chromaticity Response Time	CS1000  CS1000  DMS703	Field  1°		
2	Definition of Viewing Angle Range and Measurement System	Φ=180° Φ=276	ormal line $\Phi = 0$ $\theta_{R}$ $\theta_{R}$	elock direction  Φ=0°		
3	Definition of Contrast Ratio (CR)		ice measured when LCD is ice measured when LCD is			



Note	ltem	Test method				
		"White state": The state is that the LCD should drive by Vwhite.  "Black state": The state is that the LCD should drive by Vblack.  Vwhite: To be determined				
		Vblack: To be determined  The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time (TON) is the time between photo detector output intensity changed from 90% to 10%. And fall time (TOFF) is the time between photo detector output intensity changed from 10% to 90%.				
4	Definition of Response  Time (T <sub>R</sub> , T <sub>F</sub> )	White(TFT OFF) Black(TFT ON) White(TFT OFF)  White(TFT OFF)  Black(TFT ON)  White(TFT OFF)  Toff				
5	Definition of Color Chromaticity (CIE1931)	Color coordinates measured at center point of LCD.				
6	Definition of Luminance Uniformity	Active area is divided into 9 measuring areas. Every measuring point is placed at the center of each measuring area.  Luminance Uniformity (U)=Lmin/Lmax  LActive area length WActive area width				



Note	ltem	Test method
		L max: The measured Maximum luminance of all measurement position.  L min: The measured Minimum luminance of all measurement position.
7	Definition of Luminance	Measure the luminance of white state at center point.



## 5. LED Backlight Specification

### 5.1 LED Backlight Characteristics

 $Ta = 25^{\circ} C$ 

ltem	Symbol	Condition	Min	Тур.	Max	Unit	Note
Forward Voltage	Vf	-	19.6	-	23.8	V	-
Forward Current	If	-	-	60	-	mA	-
Operating LifeTime	-	-	30000	-	-	Hours	-

Note 1: Ta means ambient temperature of TFT-LCD module.

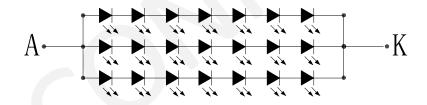
Note 2: IF, VF are defined for one channel LED. There are two LED channel in back light unit.

**Note 3:** If the module is driven by high current or at high ambient temperature & humidity condition. The operating life will be reduced.

**Note 4:** Operating life means brightness goes down to 50% initial brightness. Minimum operating lifetime is estimated data.

#### 5.2 INTERNAL CIRCUIT DIAGRAM

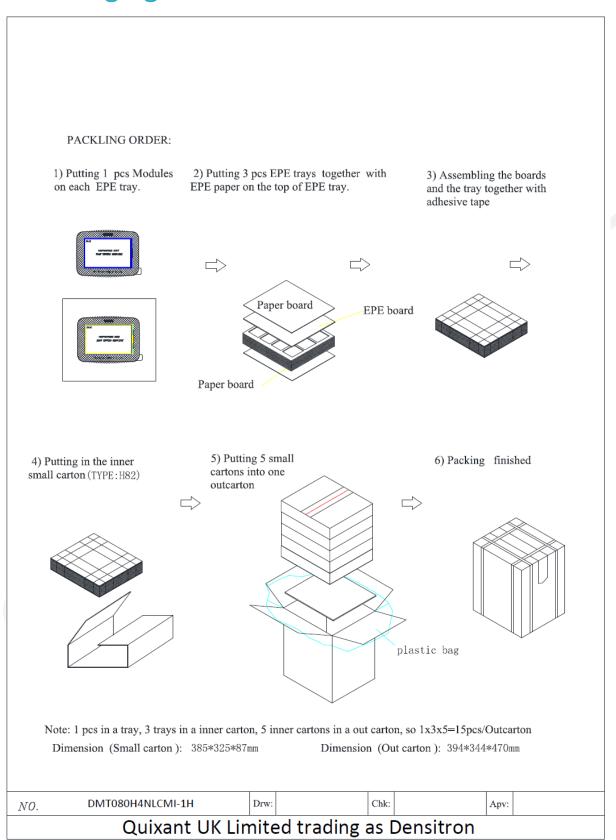
LED CIRCUIT DIAGRAM:



Vf = 19.6V(MIN), 23.8V(MAX.) @ IF = 60mA



## 6. Packaging





## 7. Quality Assurance Specification

### 7.1 Conformity

The performance, function and reliability of the shipped products conform to the Product Specification.

#### 7.2 Environment Required

Customer's test & measurement are required to be conducted under the following conditions:

Temperature:  $25 \pm 5^{\circ}$ C

Humidity:  $65\% \pm 5\% \text{ RH}$ 

Illumination: under 40W fluorescent light

Viewing distance:  $35 \pm 5 \text{ cm}$ 

Finger glove (or finger cover) must be worn by the inspector.

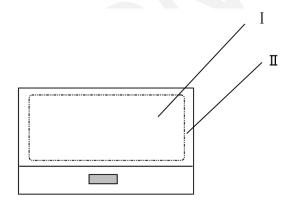
Inspection table or jig must be anti-electrostatic.

#### 7.3 Delivery Assurance

#### 7.3.1 Delivery Inspection Standards

Class II, Normal Inspection, MIL-STD-105E

#### 7.3.2 Zone Definition



I area: viewing area

 $\Pi$  area: outside viewing area



### 7.3.3 Criteria & Acceptable Quality Level

Partition	AQL	Definition
Major (MA)	0.65	1. Liquid crystal leakage  2. Wrong polarizer  3. Outside dimension  4. Bright dot, dark dot  5. Display abnormal  6. Class crack
Minor (MI)	1.0	1. Spot defect (including black spot, white spot, pinhole, foreign particle, bubbles, hurt) 2. Fragment 3. Line defect (including black line, white line, scratch) 4. Incision defect 5. Newton's ring 6. Other visual defects

### 7.3.4 Packing Inspection

Standard of appearance test for I area: (unit: mm)

Note: Defect ignore for  $\ensuremath{\Pi}$  area.

#### 7.3.5 Criteria & Classification

#### **Bright/Dark Dots explain**

Item	Description	Definition
	Dots appear bright and unchanged in size in which LCD panel is displaying under black pattern.	
		The definition of dot: The size of a defective dot over 1/2 of single pixel
Bright Dot		dot is regarded as one defective dot.
	Bright Dot	<b>Note:</b> One pixel consists of 3 subpixels, including R, G, and B dot.  (Sub-pixel = Dot)
Dark Dot	Dots appear dark and unchanged in size in which LCD panel	
Daik Dot	is displaying under pure red, green, blue pattern.	



ltem	Description	Definition
Adjacent Dot	Adjacent two sub-pixel are defect (define two dot defect)	

#### **Inspection Standard**

Units: mm

No.	Item	Criterion			Checking Manner	Defect Classes	
1	Bright/dark dot	5mm.	4.3" < LCD < 7"  Bright dot: N≤3  Dark dot: N≤4  Total: N≤6  en the two defect dots and defect N≤0			Checking with eyes	Maj -
2	Spot defects (black and white spot, pinhole, foreign matter, dent, backlight foreign matter)  D=(X+Y)/2	D≤0.15 Ignore 0.15 < D≤0.3 N≤3 0.3 < D N=0	D≤0.2 Ignore 0.2 < D≤0.5 N≤4 0.5 < D N=0	D≤0.2 Ignore 0.2 < D≤0.5 N≤5 0.5 < D N=0	D≤0.2 Ignore 0.2 < D≤0.5 N≤6 0.5 < D N=0	Checking with eyes	Min



No.	ltem		Criterion			Checking Manner	Defect Classes
3	Bubble  The state of the state	D≤0.2 Ignore 0.2 < D≤0.5 N≤3 0.5 < D N=0	D≤0.2 Ignore 0.2 < D≤0.5 N≤4 0.5 < D N=0	D≤0.2 Ignore 0.2 < D≤0.5 N≤5 0.5 < D N=0	D≤0.2 Ignore 0.2 < D≤0.5 N≤6 0.5 < D N=0	Checking with eyes	Min
4	Line defects (Black and white line, backlight foreign matter etc.)	W≤0.03 Ignore 0.03 < W≤0.06 L≤5 N≤3 W > 0.06 L>5 N=0	W≤0.03 Ignore 0.03 < W≤0.1 L≤5 N≤4 W>0.1 L>5 N=0	W≤0.03 Ignore 0.03 < W≤0.1 L≤5 N≤5 W>0.1 L>5 N=0	W≤0.03 Ignore 0.03 < W≤0.1 L≤5 N≤6 W>0.1 L>5 N=0	Checking with eyes	Min
5	Scratch	W≤0.03 Ignore $0.03 < W \le 0.2$ $1.0 < L \le 5.0$ N≤3 W>0.2 L>5 N=0	W≤0.03 Ignore 0.03 < W≤0.2 1.0 < L≤ 5.0 N≤4 W>0.2 L>5 N=0	W≤0.03 Ignore 0.03 < W≤0.2 1.0 < L≤ 5.0 N≤5 W>0.2 L>5 N=0	W≤0.03 Ignore 0.03 < W≤0.2 1.0 < L≤ 5.0 N≤6 W>0.2 L>5 N=0	Checking with eyes	Min
6	Display abnormal	Not allowed			Checking with eyes	Maj	
7	Outside dimension	Accord with drawing			Calipers	Maj	
8	Glass crack	Not allowed			Checking with eyes	Maj	
9	Leak	Not allowed			Checking	Maj	



No.	Item	Criterion		Checking Manner	Defect Classes
				with eyes	
10	Comer and side fragment	X Y Y Y	<ol> <li>Comer fragment:</li> <li>X, Y≤1mm Z≤T/2→</li> <li>allowed</li> <li>Side fragment:</li> <li>X≤2.0mm Y≤1mm Z≤T/2</li> <li>→allowed</li> </ol>	Calipers & Eyes	Min
11	Crack		NG	Eyes	Maj
12	Newton's ring ( CTP or Cover board )		Newton's ring <1/9 area, after Lightened, no influence on words and lines.	Checking with eyes	Min

#### **TP Standard**

No.	ltem	Picture	Criterion	Checking	Defect
				Manner	Classes
1	Outside dimension			Calipers &	
1	Outside dimension	-	Accord with drawing	Eyes	min
			Obvious deviation		
2	Color deviation	Difference of ink color	compared	Eyes	Min
			with samples		
		para.	No any holes near VA		
	Ink pinhole		side 3mm		
3			Out of VA: D≤0.15mm	Eyes Film	Min
			N≤1, no present in		
			reflection condition.		
4	Ink saw tooth		W≤0.15mm N=1	Eyes Film	Min



No.	ltem	Picture	Criterion	Checking Manner	Defect Classes
5	Ink light leakage		1 \ width of light leakage at the edge area ≤0.15mm OK 2 \ width of light leakage at the edge area >0.15mm NG	Eyes Film	Min
6	Cover glass profile	-	No ink, adhesive, oil stain, etc.	Eyes	Min
7	IR(LED)dot/black-white	, K	$\varphi \le 0.2$ ` N $\le 1$ 0.15< $\varphi$ ` not allowed	Eyes& Film	Min
8	IR(LED)dot blackwhite dot/different color		no present when use all viewing angle to determine at 35cm, allowed	Eyes	Min
9	Shooting hole		$\varphi \leq 0.2 \text{ `N} \leq 1$ 0.15< $\varphi$ ` not allowed	Eyes& Film	Min
10	LOGO/ICON black-white dot	Q	Diagram clear φ≤0.2 \ N≤1	Eyes& Film	Min
11	FPC warped		ОК	Eyes	Min
12	FPC broken, stained, oxidation		NG	Eyes	Maj
13	Stain	-	No evident finger print, oil print, gelatinoids, etc.	Eyes	Min
14	Sponge	-	Presented in AA area.	Eyes	Min
15	Protection foil	Finished Protection foil	1 · Protection foil stain: In normal inspection	Eyes& Film	Min



No.	ltem	Picture	Criterion	Checking Manner	Defect Classes
			Condition, fingerprint, pen print and gelatinoids are presented. NG  2 \ Bubble≤5.0mm, or according to client's limited sample  3 \ Protection foil worn and warped \ NG  4 \ Scratch: W≤0.10mm, ignore length; 0.10mm < W≤0.20mm, L≤30mm, and N≤4, d>15mm; OK;L  >30mm  or W>0.20mm; NG		



### 7.4 Dealing with Customer Complaints

#### 7.4.1 Non-conforming Analysis

Purchaser should supply Densitron with detailed data of non-conforming sample.

After accepting it, Densitron should complete the analysis in two weeks from receiving the sample.

If the analysis cannot be completed on time, Densitron must inform the purchaser.

#### 7.4.2 Handling of Non-conforming Displays

If any non-conforming displays are found during customer acceptance inspection which Densitron is clearly responsible for, return them to Densitron.

Both Densitron and customer should analyse the reason and discuss the handling of non-conforming displays when the reason is not clear.

Equally, both sides should discuss and come to agreement for issues pertaining to modification of Densitron quality assurance standard.



## 8. Reliability Specification

### 8.1 Reliability Tests

Test Item	Test Condition	Evaluation and assessment		
High Temperature Storage	60±2°C /240 hours			
Low Temperature Storage	-20±2℃/240 hours			
High Temperature Operating	50±2°C /240 hours			
Low Temperature Operating	-10±2℃/240 hours	Inspection after 2~4hours storage at room temperature, the sample		
Temperature Cycle	-20°C ~ 25°C ~ 60°C × 10cycles (30min.) (5min.) (30min.)			
Damp Proof Test	40°C ±5°C ×90%RH/240 hours	shall be free from defects:		
Vibration Test	Frequency: 10Hz~55Hz~10Hz  Amplitude: 1.5mm,  X · Y · Z direction for total 3hours  (Packing condition)	<ul><li>1.Air bubble in the LCD;</li><li>2.Sealleak;</li><li>3.Non-display;</li><li>4.Missing segments;</li></ul>		
Dropping test	Drop to the ground from 1m height, one time, every side of carton. (Packing condition)	<ul><li>5.Glass crack;</li><li>6.Current Idd is twice higher than</li></ul>		
ESD test	Voltage: ±8KV  R: 330Ω C: 150pF  Air discharge, 10time  Voltage: ±6KV  R: 330Ω C: 150pF  Contact discharge, 10time	initial value.		

**Note 1:** The test samples should be applied to only one test item.

Note 2: Sample size for each test item is 5~10pcs.

**Note 3:** For Damp Proof Test, Pure water(Resistance  $> 10M\Omega$ ) should be used.

**Note 4:** In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judge as a good part.

**Note 5:** Failure Judgment Criterion: Basic Specification, Electrical Characteristic, Mechanical Characteristic, Optical Characteristic.

Note 6: Please use automatic switch menu (or roll menu) testing mode when test operating mode.

#### 8.1.1 Inspection Check Standard

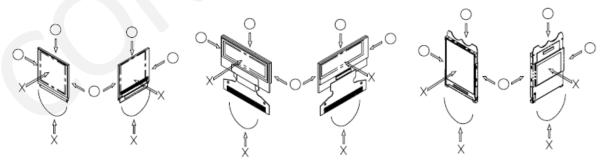
After the completion of the described reliability test, the samples are to be left at room temperature for 4 hrs prior to conducting the inspection check at  $25\pm5$  °C,  $65\pm5\%$  RH.



## 9. Handling Precautions

### 9.1 Handling Precautions

- 1) Since the display panel is being made of glass, do not apply mechanical impacts such as dropping from a high position.
- 2) If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance.
- 3) If the liquid crystal touches your skin or clothes, wash it off immediately using soap and plenty of water
- 4) If pressure is applied to the display surface or its neighbourhood of the display module, the cell structure may be damaged and be careful not to apply pressure to these sections.
- 5) The polarizer covering the surface of the display module is soft and easily scratched. Please be careful when handling the display module.
- 6) When the surface of the polarizer of the display module has soil, clean the surface. It takes advantage of by using following adhesion tape.
  - a. Scotch Mending Tape No. 810 or an equivalent
  - b. Never try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent such as ethyl alcohol, since the surface of the polarizer will become cloudy.
  - c. Also, pay attention that the following liquid and solvent may spoil the polarizer:
    - Water
    - Ketone
    - Aromatic Solvents
- 7) Hold the display module very carefully when placing it into the system housing. Do not apply excessive stress or pressure to display module. And, do not over bend the film with electrode pattern layouts. These stresses will



influence the display performance. Also, secure sufficient rigidity for the outer cases.

- 8) Do not apply stress to the LSI chips and the surrounding molded sections.
- 9) Do not disassemble nor modify the display module.
- 10) Do not apply input signals while the logic power is off.
- 11) Pay sufficient attention to the working environments when handing display modules to prevent occurrence of element breakage accidents by static electricity.



- a. Be sure to make human body grounding when handling display modules.
- b. Be sure to ground tools to use or assembly such as soldering irons.
- c. To suppress generation of static electricity, avoid carrying out assembly work under dry environments.
- d. Protective film is being applied to the surface of the display panel of the display module. Be careful since static electricity may be generated when exfoliating the protective film.
- 12) Protection film is being applied to the surface of the display panel and removes the protection film before assembling it. If the display module has been stored for a long period of time, residue adhesive material of the protection film may remain on the surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above Section 5).
- 13) If electric current is applied when the display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful to avoid the above.

#### 9.2 Storage Precautions

- 1) When storing display modules, put them in static electricity preventive bags avoiding exposure to direct sun light nor to lights of fluorescent lamps, etc. and, also, avoiding high temperature and high humidity environments or low temperature (less than 0°C) environments. (We recommend you to store these modules in the packaged state when they were shipped from Densitron) At that time, be careful not to let water drops adhere to the packages or bags nor let dewing occur with them.
- 2) If electric current is applied when water drops are adhering to the surface of the display module, when the display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful about the above.

#### 9.3 Designing Precautions

- 1) The absolute maximum ratings are the ratings which cannot be exceeded for display module, and if these values are exceeded, panel damage may be happen.
- 2) To prevent occurrence of malfunctioning by noise, pay attention to satisfy the VIL and VIH specifications and, at the same time, to make the signal line cable as short as possible.
- 3) We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (VDD). (Recommend value: 0.5A)
- 4) Pay sufficient attention to avoid occurrence of mutual noise interference with the neighbouring devices.
- 5) As for EMI, take necessary measures on the equipment side basically.
- 6) When fastening the display module, fasten the external plastic housing section.
- 7) If power supply to the display module is forcibly shut down by such errors as taking out the main battery while the display panel is in operation, we cannot guarantee the quality of this display module.



#### 9.4 Operation Precautions

- 1) It is indispensable to drive the display within the specified voltage limit since excessive voltage shortens its life.
- 2) Direct current causes an electrochemical reaction with remarkable deterioration of the display quality. Give careful consideration to prevent direct current during ON/OFF timing and during operation.
- 3) Response time is extremely delayed at temperatures lower than the operating temperature range while, at high temperatures, displays become dark. However, this phenomenon is reversible and does not mean a malfunction or a display that has been permanently damaged.
- 4) To protect display modules from performance drops by static electricity rapture, etc., do not touch the following sections whenever possible while handling the display modules.
  - a. Pins and electrodes
  - b. Pattern layouts such as the FPC
- 5) When the driver is being exposed (COG), semiconductor elements change their characteristics when light is radiated according to the principle of the solar battery. Consequently, if the driver is exposed to light, malfunctioning may occur.
  - a. Design the product and installation method so that the driver may be shielded from light in actual usage.
  - b. Design the product and installation method so that the driver may be shielded from light during the inspection processes.
- 6) Although the display module stores the operation state data by the commands and the indication data, when excessive external noise, etc. enters into the module, the internal status may be changed. It therefore is necessary to take appropriate measures to suppress noise generation or to protect from influences of noise on the system design.
- 7) We recommend you to construct its software to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise.

#### 9.5 Other Precautions

1) Request the qualified companies to handle industrial wastes when disposing of the display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations.